



## High performing SOFC via multilayer tape casting?

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# High performing SOFC via multilayer tape casting?

**Aim – Decreased SOFC manufacturing cost while keeping high fuel cell performance:**

Substitute processing steps that have low material yield (e.g. spraying) and those not suitable for industrial scale production.

Decrease number of sintering steps and handling efforts.

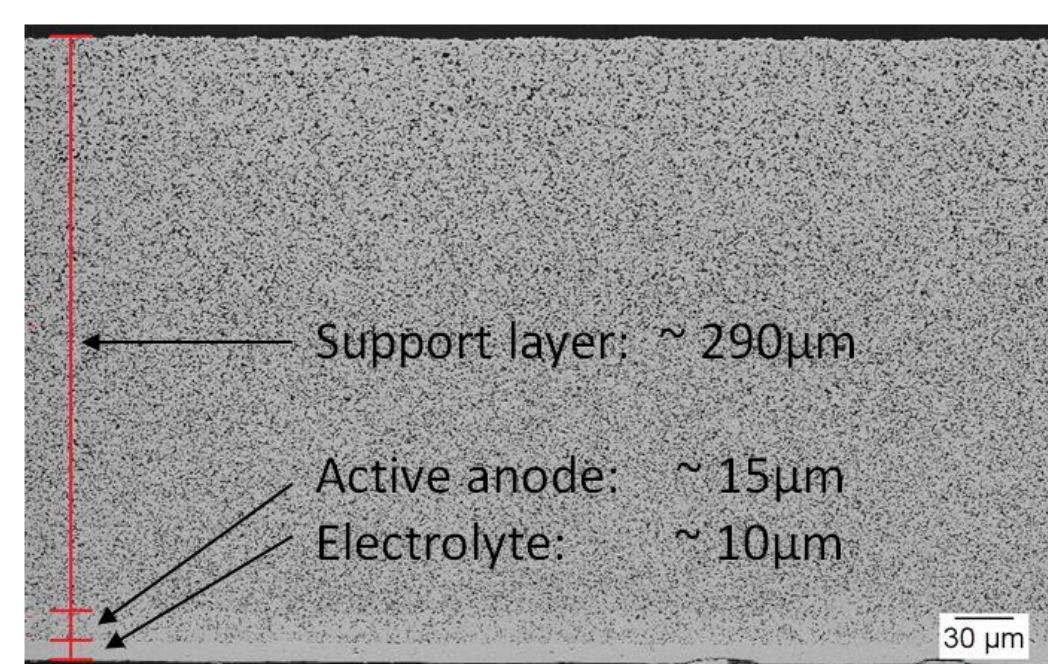
→ Multilayer tape casting (MTC) and co-sintering of support layer, anode and electrolyte could be a solution!

**Questions:**

- Can the entire anode half cell be produced via multilayer tape casting?
- Can we co-cast anode and electrolyte layers at thicknesses of just 10-15µm?
- Can we obtain optimal microstructures for all half cell components in one single sintering step providing high performing anodes?

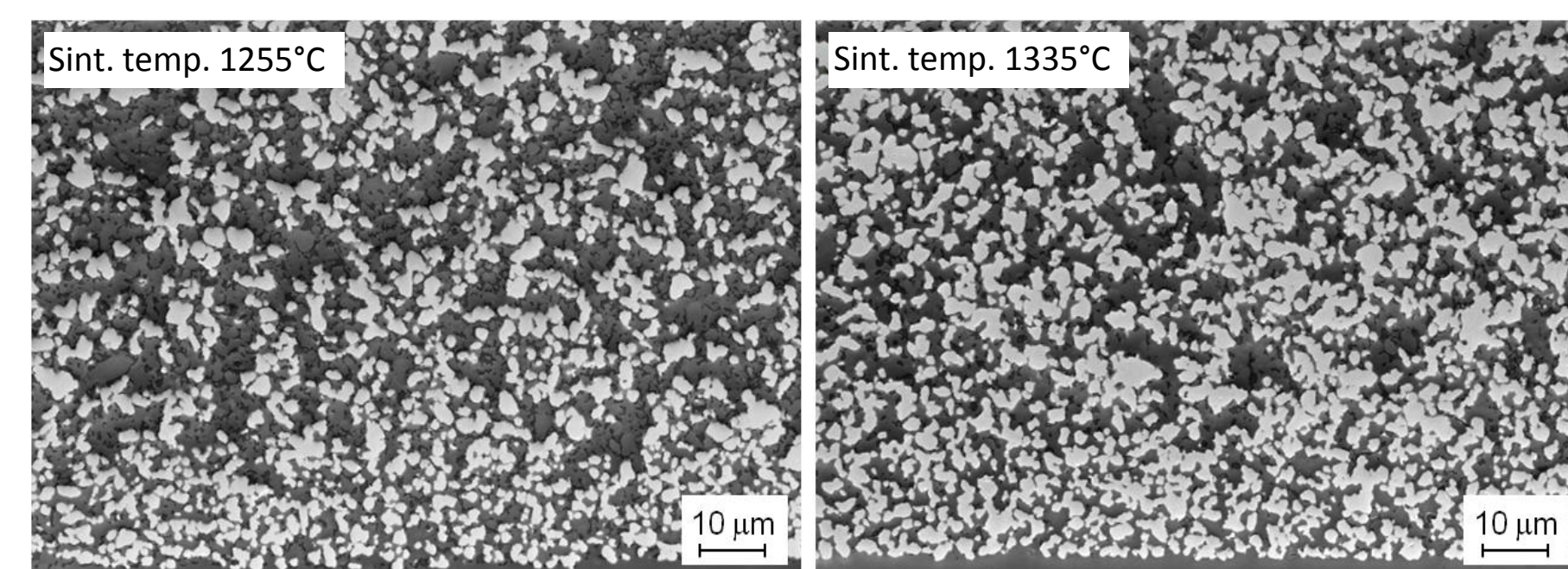
## Microstructure

### The MTC anode half-cell



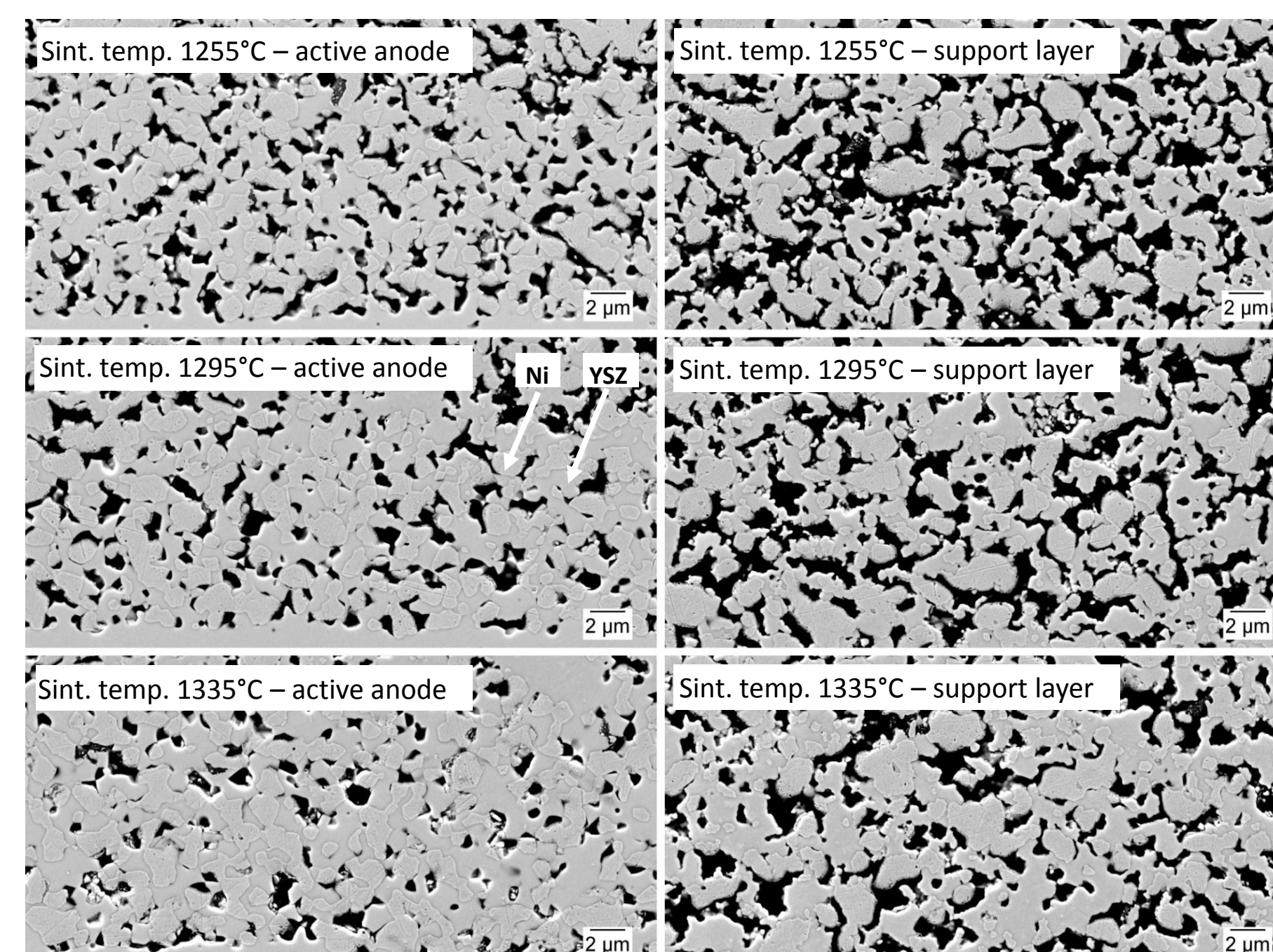
**Figure 1:** High voltage SE-detector SEM image of reduced, non-tested MTC half-cell sintered at 1315°C.

### Low voltage SEM: The percolating Ni network



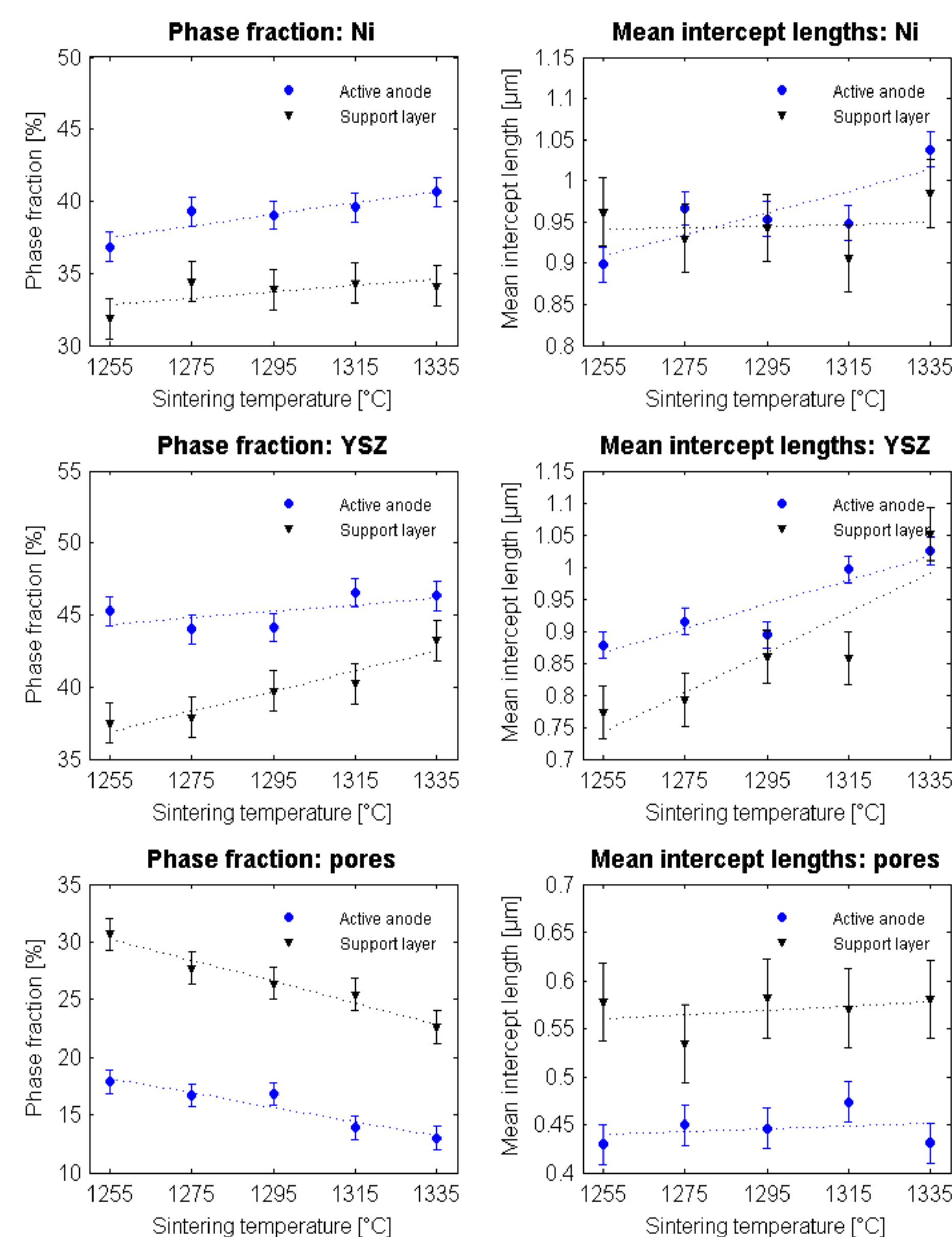
**Figure 2:** Low voltage (0.9kV) in-lens SEM images of reduced, non-tested MTC half cells. Bright particles constitute the percolating Ni-network.

### High voltage SEM: Impact of sint. temperature



**Figure 3:** High voltage (8 kV) SE-detector SEM images of reduced, non-tested MTC half-cells. Pores appear black. Ni and YSZ phases are designated in the image of the 1295-cell.

### Microstructural analysis: Phase fractions and mean intercept lengths



**Figure 4:** Microstructural analysis of reduced, non-tested half-cells sintered at 1255°C, 1275°C, 1295°C, 1315°C and 1335°C. Uncertainties for the measured intercept lengths are app.  $\pm 0.04\mu\text{m}$  and  $\pm 1.4\%$  for phase fractions. Measurements were performed on high voltage SE-detector images, at 11.3 kX (Figure 3), using in-house developed Matlab-based software ManSegv0.31. A minimum of 1000 line intercepts were measured for each phase in anode and support of all 5 cell samples.

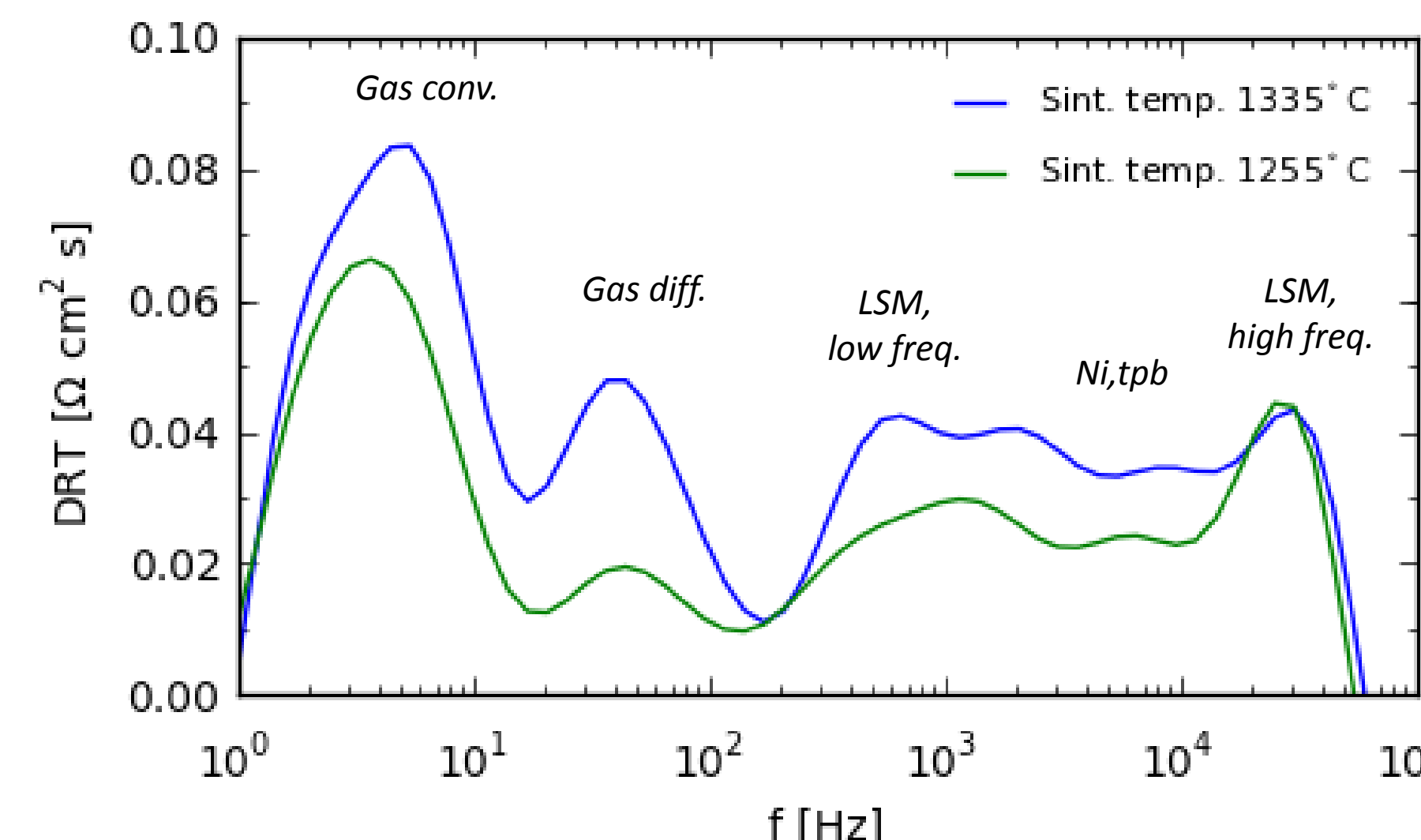
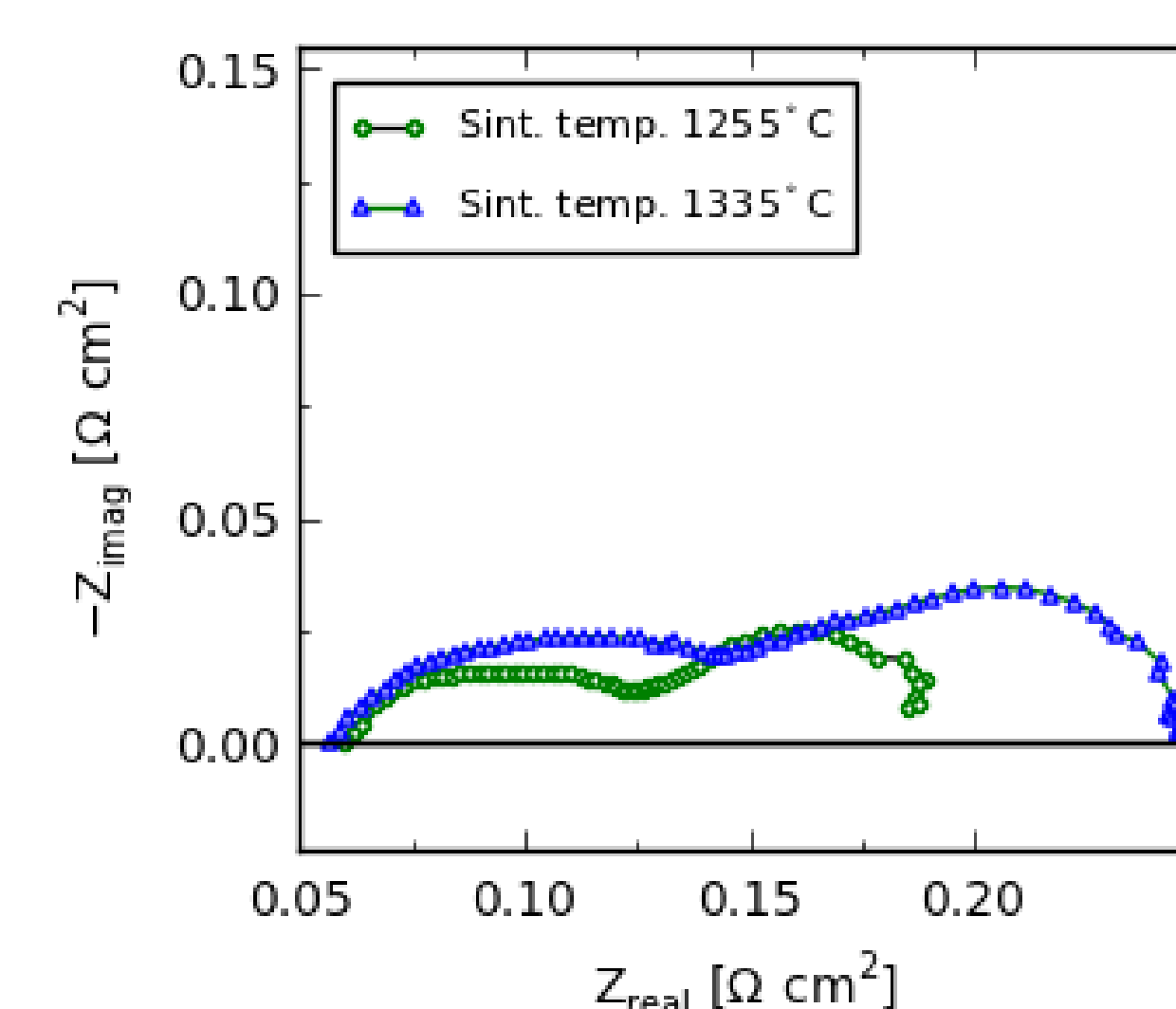
## Findings

DTU Energy Conversion produce SOC anode half-cells by MTC and co-sintering in a pre-pilot plant. Investigations of microstructure and performance of cells (Ni/3YSZ-Ni/8YSZ-8YSZ-LSM/YSZ) with MTC anodes reveal:

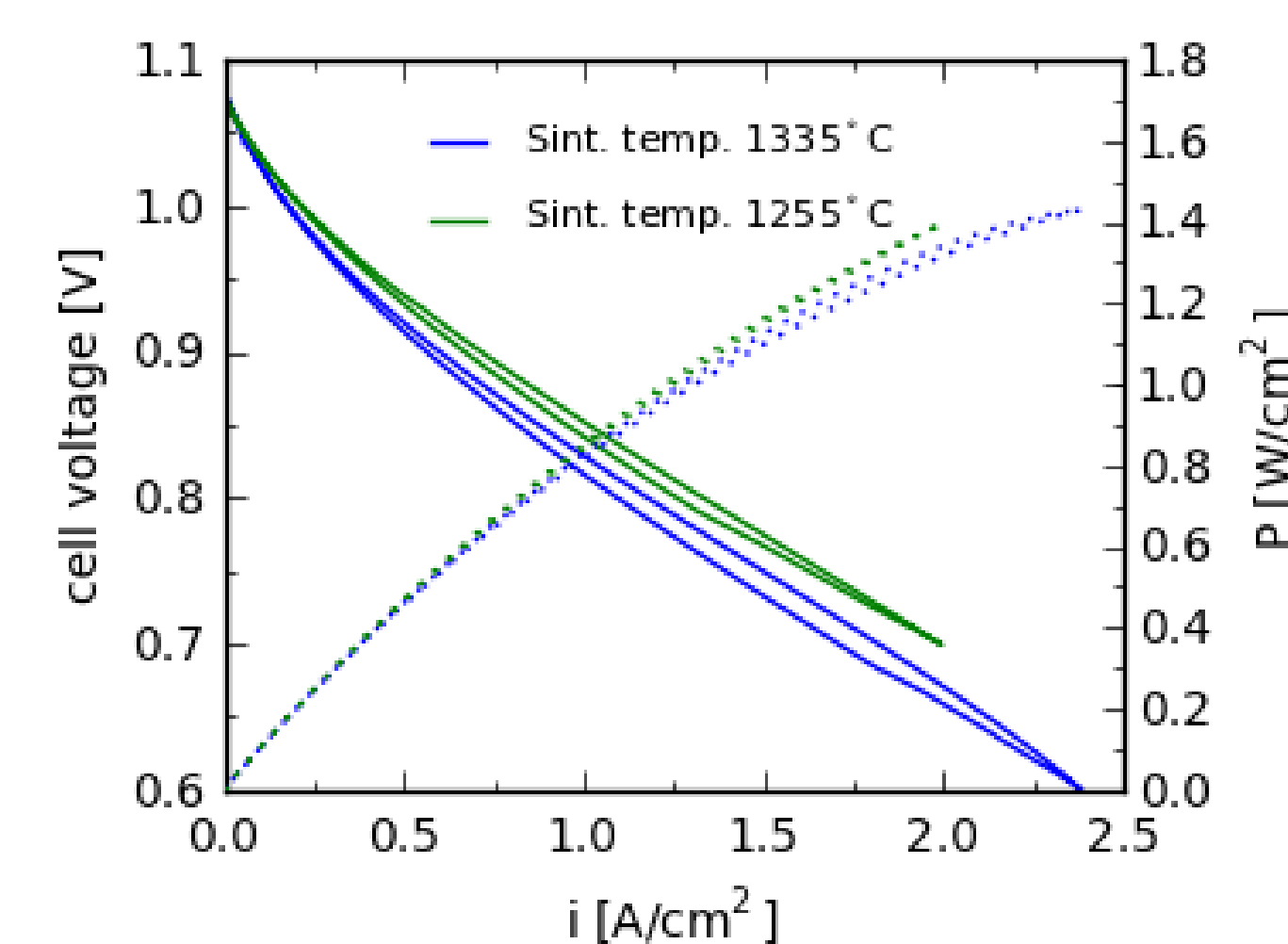
- 1) A “window” for the co-sintering from 1255°C to 1335°C
- 2) Uniform microstructures of desired thicknesses, porosities, particle sizes and percolation
- 3) High initial performance
- 4) Correlations of microstructure and performance with sintering temperature — increased porosity and decreased Ni particle size with lower sintering temperature  $\Rightarrow$  decreased gas diffusion and charge transfer reaction resistance in the Ni/YSZ anode half cell.

## Electrochemical performance

### Performance analysis: EIS, DRT, iV

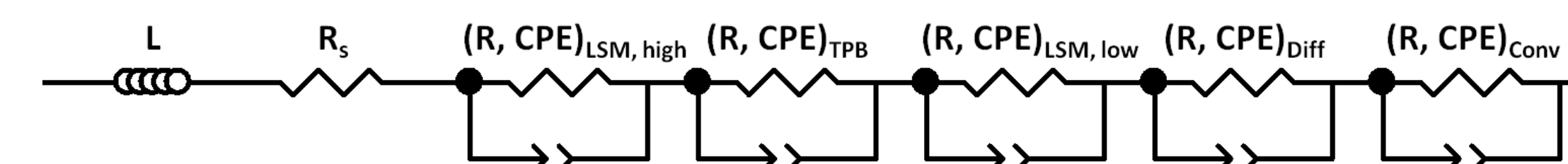


**Figure 5:** Nyquist (left) and DRT plot (right) of impedance spectra (IS) at 850°C, OCV, air to the cathode, 21-23%  $\text{H}_2\text{O}$  in  $\text{H}_2$  to the anode. The Nyquist plot is corrected for inductance.



**Figure 6:** IV curves at 850°C, air to the cathode, 4%  $\text{H}_2\text{O}$  in  $\text{H}_2$  to the anode.

### EIS analysis: CNLS fitting



**Figure 7:** Equivalent circuit model applied in CNLS fitting of IS shown in Figure 5. Inductance L and series resistance  $R_s$  are connected in series with 5 RQ elements, representative of the polarisation resistance. Corresponding results are given in Table 1.

Sint. temp.	ASR <sub>FU</sub> (mΩcm <sup>2</sup> )	R <sub>s</sub> (mΩcm <sup>2</sup> )	R <sub>tpb</sub> (mΩcm <sup>2</sup> )	f <sub>s,tpb</sub> (Hz)	R <sub>Diff</sub> (mΩcm <sup>2</sup> )	f <sub>s,Diff</sub> (Hz)	R <sub>Conv</sub> (mΩcm <sup>2</sup> )	f <sub>s,Conv</sub> (Hz)
1255°C	128	51	52	8442	15	39	51	4
1335°C	158	42	85	7112	34	39	61	4

**Table 1:** ASR<sub>FU</sub> at 700 mV from iV-curves in Figure 6 and resistances and summit frequencies from CNLS-fit of the IS shown in Figure 5. Estimated error for the resistances  $\sim 3 \text{ m}\Omega\text{cm}^2$ .

## Sintering temperature: 1255°C → 1335°C

### Microstructure



### Cell performance

- 1) Lower porosity  
(support: from 31% to 23%; active anode: from 18% to 13%)
- 2) Ni particle coarsening  
(active anode: from 0.88  $\mu\text{m}$  to 1.03  $\mu\text{m}$ )

- 1)  $\sim 2$ -fold increase in gas diffusion resistance
- 2) Increase in charge transfer reaction resistance from 52 mΩcm<sup>2</sup> to 85 mΩcm<sup>2</sup> (850 °C)